

PTM7000

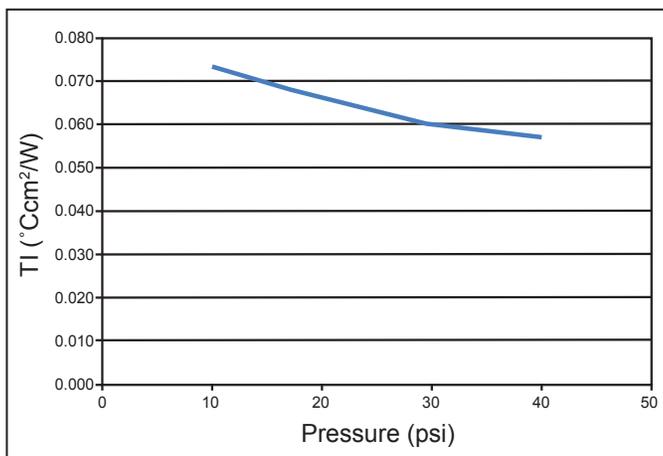
High Thermal Conductivity Phase Change Material

Honeywell's PTM7000 series, a super highly thermally conductive Phase Change Material (PCM) in both pad and paste formats, is designed to minimize thermal resistance at interfaces, maintain excellent performance through reliability testing, and provide scalable application at a competitive cost.

Based on a novel polymer PCM system, this material exhibits excellent interface wettability during typical operating temperature ranges, resulting in extremely low surface contact resistance.

A proprietary material provides superior reliability (pass 150 °C baking 1000 hours, HAST 96 hours, T/C-B 1000 cycles) and maintains low thermal impedance (<0.07 °Ccm²/W @ no shim), making the PTM7000 Series desirable for high-performance integrated circuit devices.

PTM7000 Thermal Impedance (TI) vs. Pressure



PTM7000 is suggested when long-term reliability is a primary need.

Honeywell TIMs Serve Multiple Applications



Automotive & Power



IT/Enterprise



Telecomm



Consumer Electronics



High-Brightness LED

FEATURES & BENEFITS

- High performance filler and polymer technology
- Highly conductive filler loading to optimize performance
- Superior handling and reworkability
- Superior reliable thermal performance
- Available in both pad and paste formats
- Phase change at 45°C

PTM7000 Technical Information

Physical Properties	Unit	Test Method	PTM7000	PTM7000-SP	PTM7000-SPM	
Thermal Conductivity	W/m·K	ASTM D5470	6.5	6.5	6.5	
Thermal Impedance @ no shim	°Ccm ² /W	ASTM D5470	0.06	0.06	0.06	
Specific Gravity	g/cm ³	ASTM D374	2.7	2.3	2.3	
Viscosity	Pa.s@2 1/s, 25 °C	Rehometer HON	NA	120	120	
Volume Resistivity	Ω cm		2.1x10 ¹⁴	2.1x10 ¹⁴	2.1x10 ¹⁴	
Thickness Range	mm		0.20-1.00	NA	NA	
Solvent Drying Time	RT(23 °C)	Hours	Honeywell Internally	NA	2.5 hours	48 hours
	100 °C	mins	Honeywell Internally	NA	2.5mins	8mins

STORAGE CONDITION

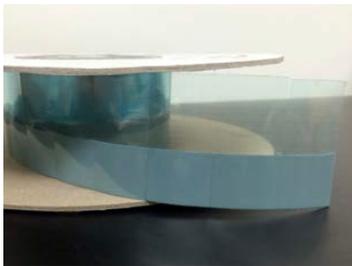
Refer to product label.

THERMAL IMPEDANCE POST RELIABILITY (ASTM E1461)

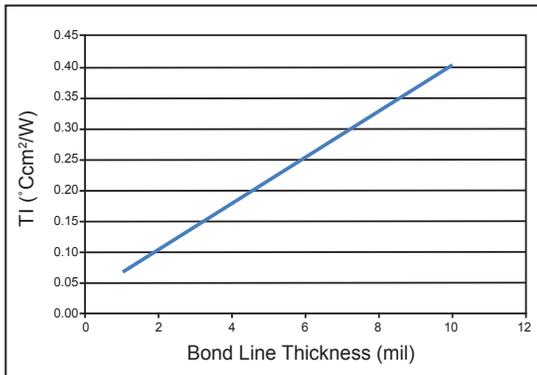
Bake 150 °C, 1000 h	0.07 °C-cm ² /W
HAST, 96 h	0.07 °C-cm ² /W
Temperature Cycling "B" (-55 °C to +125 °C, 1000 cycles)	0.06 °C-cm ² /W

Product Use

Clamping pressure and temperature are suggested to achieve a minimum bond line thickness of the thermal interface material, typically less than 1.5 mil (0.038mm) for best performance. The material must go through the phase change temperature to exhibit entitlement performance.



PTM7000 is available in both pad and paste/printable formats



PTM7000 Thermal Impedance vs. Bond Line Thickness

More Honeywell TIMs

PTM7000 is part of Honeywell's TIM Solutions family of phase change materials. Whatever the thermal challenge, we offer a TIM product that provides just the right characteristics for your application. Find out more about:

- PTM7000 Series
- PTM6000 Series
- PTM5000 Series
- PCM45F Series
- LTM Series

By visiting: electronicmaterials.com

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